



06-10-04

2823
JFW

Filed Via Express Mail pursuant to 37 C.F.R. 1.10

Record No.: EV 332 248 415 US

On: JUNE 8, 2004

By:

LINDA E. HASTINGS

Any fee due as a result of this paper, not covered by an enclosed check, may be charged on Deposit Acct. No. 50-1290.

Attorney Docket No.:NECB 19.265 (100806-00068)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor: Michiaki MARUOKA

Serial No.: 10/024,103

Filed: December 17, 2001

Title: **SEMICONDUCTOR DEVICE HAVING BONDING PAD
ELECTRODE OF MULTI-LAYER STRUCTURE**

Examiner: Khiem D. Nguyen

Group Art Unit: 2823

Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

SIR:

In response to the Office Action mailed on March 9, 2004, the period for responding thereto having been set to expire after June 9, 2004, please amend the subject application as follows:

06/14/2004 CNGUYEN 00000100 501290 10024103

01 FC:1201 86.00 DA